SDAS300 – MARCH 1995

- Bidirectional Bus Transceivers in High-Density 20-Pin Packages
- Choice of True or Inverting Logic
- Package Options Include Plastic Small-Outline (DW) Packages and Standard Plastic (N) 300-mil DIPs

DEVICE	LOGIC
SN74ALS641A, SN74AS641	True
SN74ALS642A	Inverting

DW OR N PACKAGE (TOP VIEW) V_{CC} DIR [20 19 0E A1 2 18 B1 A2 🛛 3 A3 4 17 🛛 B2 A4 🛛 5 16 🛛 B3 15 B4 A5 🛛 6 14 🛛 B5 A6 🛛 7 A7 🛛 8 13 B6 A8 🛙 9 12 B7 GND 10 11 🛛 B8

description

These octal bus transceivers are designed for asynchronous two-way communication between

data buses. These devices transmit data from the A bus to the B bus or from the B bus to the A bus, depending upon the level at the direction-control (DIR) input. The output-enable (\overline{OE}) input disables the device so that the buses are effectively isolated.

The -1 versions of the SN74ALS641A and SN74ALS642A are identical to the standard versions, except that the recommended maximum I_{OL} is increased to 48 mA in the -1 versions.

The SN74ALS641A, SN74ALS642A, and SN74AS641 are characterized for operation from 0°C to 70°C.

		I ONOTION TABE					
INP	UTS	OPERATION					
OE	DIR	SN74ALS641A SN74AS641	SN74ALS642A				
L	L	B data to A bus	B data to A bus				
L	Н	A data to B bus	A data to B bus				
Н	Х	Isolation	Isolation				

FUNCTION TABLE

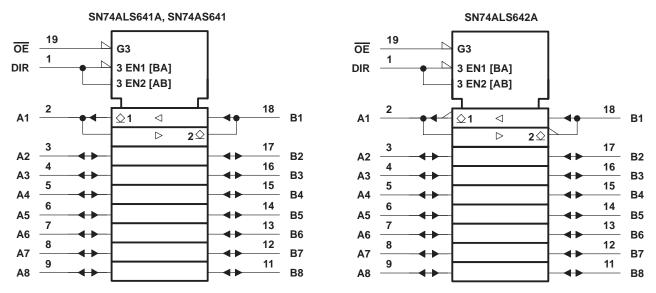
PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



POST OFFICE BOX 655303 • DALLAS, TEXAS 75265 POST OFFICE BOX 1443 • HOUSTON, TEXAS 77251–1443

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logic symbols[†]



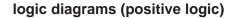
[†] These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

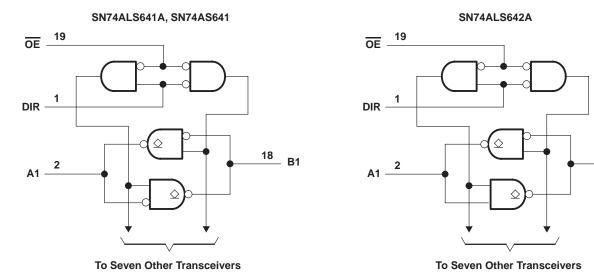


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B1





absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage, V _{CC}
Input voltage, V _I : All inputs and I/O ports
Operating free-air temperature range, T _A : SN74ALS641A, SN74ALS642A 0°C to 70°C
Storage temperature range

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

			-	4ALS64 4ALS64		UNIT
		Ν	MIN	NOM	MAX	
V _{CC}	Supply voltage		4.5	5	5.5	V
V_{IH}	High-level input voltage		2			V
VIL	Low-level input voltage				0.8	V
VOH	High-level output voltage				5.5	V
	Level and and an annext				24	
IOL	Low-level output current				48‡	mA
ТА	Operating free-air temperature		0		70	°C

 \pm Applies only to the -1 version and only if V_{CC} is between 4.75 V and 5.25 V



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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CO	ONDITIONS	-	SN74ALS641A SN74ALS642A			
				MIN	TYP†	MAX		
VIK		V _{CC} = 4.5 V,	lj = – 18 mA			-1.5	V	
IOH		$V_{CC} = 4.5 V,$	V _{OH} = 5.5 V			0.1	mA	
			I _{OL} = 12 mA		0.25	0.4		
VOL		V _{CC} = 4.5 V I _{OL} = 24 mA			0.35	0.5	V	
			I _{OL} = 48 mA‡		0.35	0.5		
Ц	Control inputs	V _{CC} = 5.5 V,	V _I = 7 V			0.1	mA	
	Control inputs		N 07N			20		
Ιн	A or B ports§	V _{CC} = 5.5 V,	V _I = 2.7 V			20	μA	
	Control inputs		N 0.4 M			-0.1		
ΊL	A or B ports§	V _{CC} = 5.5 V,	V _I = 0.4 V			-0.1	mA	
	017441-00444		Outputs high		25	37		
1	SN74ALS641A	V _{CC} = 5.5 V	Outputs low		33	47	mA	
lcc	SN74ALS642A		Outputs high		8	15	ШA	
	3N/4AL3042A	V _{CC} = 5.5 V	Outputs low		18	28		

[†] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

 \ddagger Applies only to the -1 version and only if V_{CC} is between 4.75 V and 5.25 V

 $\$ For I/O ports, the parameters IIH and IIL include the off-state output current.

switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	CL RL	$V_{CC} = 4.5 V \text{ to } 5.5 V,$ $C_{L} = 50 \text{ pF},$ $R_{L} = 680 \Omega,$ $T_{A} = \text{MIN to MAX}$ SN74ALS641A SN74ALS642A		UNIT	
			SN74AL			S642A	
			MIN	MAX	MIN	MAX	
^t PLH	A D	5.4	5	25	10	30	
^t PHL	A or B	B or A	3	18	5	22	ns
^t PLH	OE	A ca D	8	30	10	30	
^t PHL	ÛE	A or B	8	30	15	38	ns
^t PLH	DIR	A or B	8	32	10	30	
^t PHL	UIK	AUID	8	32	15	38	ns

¶ For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage, V _{CC}	V
Input voltage, V _I : All inputs and I/O ports	V
Operating free-air temperature range, T _A : SN74AS641	С
Storage temperature range	С

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

		SN	SN74AS641 MIN NOM MAX		
		MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	V
VIH	High-level input voltage	2			V
VIL	Low-level input voltage			0.8	V
VOH	High-level output voltage			5.5	V
I _{OL}	Low-level output current			64	mA
TA	Operating free-air temperature	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

				SI	N74AS64	1	
	PARAMETER	TEST CO	ONDITIONS	MIN	TYP‡	MAX	UNIT
VIK		$V_{CC} = 4.5 V,$	l _l = – 18 mA			-1.2	V
IOH		$V_{CC} = 4.5 V,$	V _{OH} = 5.5 V			0.1	mA
VOL		$V_{CC} = 4.5 V,$	IOL = 64 mA		0.35	0.55	V
	Control inputs		VI = 7 V			0.1	
1j	A or B ports	V _{CC} = 5.5 V	V _I = 5.5 V			0.1	mA
	Control inputs					20	
ΙН	A or B ports§	V _{CC} = 5.5 V,	V _I = 2.7 V			70	μA
	Control inputs					-0.5	
ΊL	A or B ports§	$V_{CC} = 5.5 V,$	V _I = 0.4 V			-0.75	mA
			Outputs high		50	82	A
ICC		V _{CC} = 5.5 V	Outputs low		84	136	mA

[‡] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

§ For I/O ports, the parameters IIH and IIL include the off-state output current.



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switching characteristics (see Figure 1)

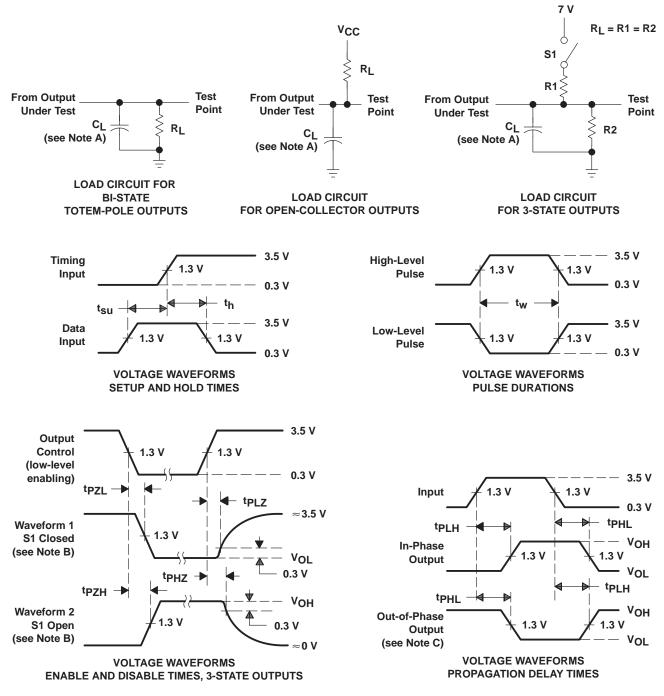
PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 4.5$ $C_L = 50 \text{ pF}$ $R_L = 680 \Omega$ $T_A = \text{MIN tr}$ SN74/ MIN	; <u>0,</u> o MAX†	UNIT
^t PLH			5	21	
^t PHL	A or B	B or A	1	7.5	ns
^t PLH	OE	A	5	21	
^t PHL	OE	A or B	1	9	ns
^t PLH	DIR	A or B	5	22	ns
^t PHL	DIR		1	10	115

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



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PARAMETER MEASUREMENT INFORMATION SERIES 54ALS/74ALS AND 54AS/74AS DEVICES



NOTES: A. CL includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
- D. All input pulses have the following characteristics: PRR \leq 1 MHz, t_f = t_f = 2 ns, duty cycle = 50%.
- E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms





6-Feb-2020

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
SN74ALS641A-1DW	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS641A-1	Samples
SN74ALS641A-1DWR	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS641A-1	Samples
SN74ALS641A-1N	ACTIVE	PDIP	Ν	20	20	Pb-Free (RoHS)	NIPDAU	N / A for Pkg Type	0 to 70	SN74ALS641A-1N	Samples
SN74ALS641A-1NSR	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS641A-1	Samples
SN74ALS641ADW	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS641A	Samples
SN74ALS641ADWR	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS641A	Samples
SN74ALS641AN	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	NIPDAU	N / A for Pkg Type	0 to 70	SN74ALS641AN	Samples
SN74ALS641ANSR	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS641A	Samples
SN74ALS642A-1DW	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS642A-1	Samples
SN74ALS642A-1N	ACTIVE	PDIP	Ν	20	20	Pb-Free (RoHS)	NIPDAU	N / A for Pkg Type	0 to 70	SN74ALS642A-1N	Samples
SN74ALS642A-1NSR	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS642A-1	Samples
SN74AS641DW	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	AS641	Samples
SN74AS641N	ACTIVE	PDIP	Ν	20	20	Pb-Free (RoHS)	NIPDAU	N / A for Pkg Type	0 to 70	SN74AS641N	Samples

⁽¹⁾ The marketing status values are defined as follows: **ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.



6-Feb-2020

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74ALS641A-1DWR	SOIC	DW	20	2000	330.0	24.4	10.8	13.3	2.7	12.0	24.0	Q1
SN74ALS641A-1NSR	SO	NS	20	2000	330.0	24.4	8.4	13.0	2.5	12.0	24.0	Q1
SN74ALS641ADWR	SOIC	DW	20	2000	330.0	24.4	10.8	13.3	2.7	12.0	24.0	Q1
SN74ALS641ANSR	SO	NS	20	2000	330.0	24.4	8.4	13.0	2.5	12.0	24.0	Q1
SN74ALS642A-1NSR	SO	NS	20	2000	330.0	24.4	8.4	13.0	2.5	12.0	24.0	Q1

TEXAS INSTRUMENTS

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PACKAGE MATERIALS INFORMATION

6-May-2017



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74ALS641A-1DWR	SOIC	DW	20	2000	367.0	367.0	45.0
SN74ALS641A-1NSR	SO	NS	20	2000	367.0	367.0	45.0
SN74ALS641ADWR	SOIC	DW	20	2000	367.0	367.0	45.0
SN74ALS641ANSR	SO	NS	20	2000	367.0	367.0	45.0
SN74ALS642A-1NSR	SO	NS	20	2000	367.0	367.0	45.0

MECHANICAL DATA

PLASTIC SMALL-OUTLINE PACKAGE

0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 5,00 7,40 \bigcirc Gage Plane ₽ 0,25 7 1 1,05 0,55 0-10 Δ 0,15 0,05 Seating Plane — 2,00 MAX 0,10PINS ** 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G**)

14-PINS SHOWN

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- \triangle The 20 pin end lead shoulder width is a vendor option, either half or full width.



DW0020A



PACKAGE OUTLINE

SOIC - 2.65 mm max height

SOIC



NOTES:

- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M. 2. This drawing is subject to change without notice. 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm per side.
- 5. Reference JEDEC registration MS-013.



DW0020A

EXAMPLE BOARD LAYOUT

SOIC - 2.65 mm max height

SOIC



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



DW0020A

EXAMPLE STENCIL DESIGN

SOIC - 2.65 mm max height

SOIC



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



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